

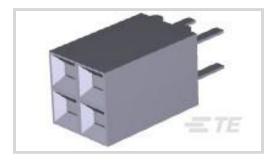
AMPMODU | Modu Connector System

TE Internal #: 5-534206-2 Modu Connector System, PCB Mount Receptacle, Vertical, Boardto-Board, 4 Position, 2.54mm [.1in] Centerline, Gold, Printed Circuit Board

View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **4**

Centerline (Pitch): 2.54 mm [.1 in]

Features

Product Type Features

Applied Pressure

PCB Connector Assembly Type

Connector System

Standard

PCB Mount Receptacle

Board-to-Board

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Rows	2
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	4
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	5000 MΩ
Operating Voltage	333 VAC
Body Features	
Connector Profile	Standard
Contact Features	
Contact Protection Type	Closed Entry Housing

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Mating Square Post Dimension	.64 mm[.025 in]
	150 µin
Contact Shape & Form	Short Point, Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A
ermination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	2.92 mm[.115 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Aechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
lousing Features	
Mating Entry Location	Тор
Centerline (Pitch)	2.54 mm[.1 in]
Housing Color	Black
Housing Material	Polyester - GF
Dimensions	
Connector Height	5.03 mm[.198 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	10.92 mm[.43 in]
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]
Jsage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

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Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	110
Packaging Method	Box & Tube, Tube
Other	
Comment	TE recommends mating gold or duplex plated headers with duplex plated receptacle assemblies., To obtain the minimum mating post length, add 0.51 [. 020] (not including the post lead in chamfer) to the maximum point-of-contact dimension.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUN 2020 (209) Candidate List Declared Against: JAN 2020 (205) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Canability	Wave solder capable to 240°C

Solder Process Capability

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent to these limits as defined in the Annexes of Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

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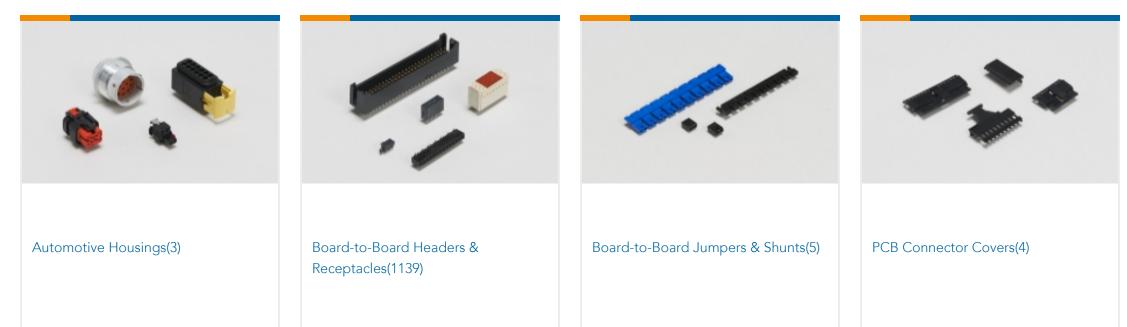


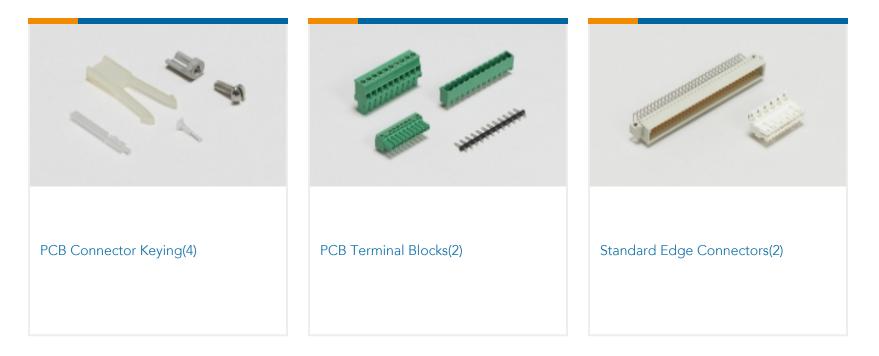
as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series | Modu Connector System





Customers Also Bought



Modu Connector System, PCB Mount Receptacle, Vertical, Board-to-Board, 4 Position, 2.54mm [.1in] Centerline, Gold, Printed Circuit Board







TE Model / Part #350180-2 TEST PROBE REC130L SPCL RED GPBR

Documents

Product Drawings 04 MODII VRT DR CE 100/115

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_5-534206-2_N.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-534206-2_N.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-534206-2_N.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

Product Specifications
Application Specification

English

Agency Approvals UL Report

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English